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(12) **United States Design Patent**  
**Martin**

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(54) **HEADPHONE ASSEMBLY**

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90014

(\*\*) Term: **14 Years**

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(51) **LOC (9) Cl.** ..... **14-01**

(52) **U.S. Cl.** ..... **D14/205**

(58) **Field of Classification Search** ..... D14/205,  
D14/206, 223, 225, 228; 379/430, 433.01,  
379/433.03, 440; 181/129; 381/380, 381;  
D29/112; 2/209; 128/864, 865  
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a headphone assembly, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a headphone assembly showing my new design.

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

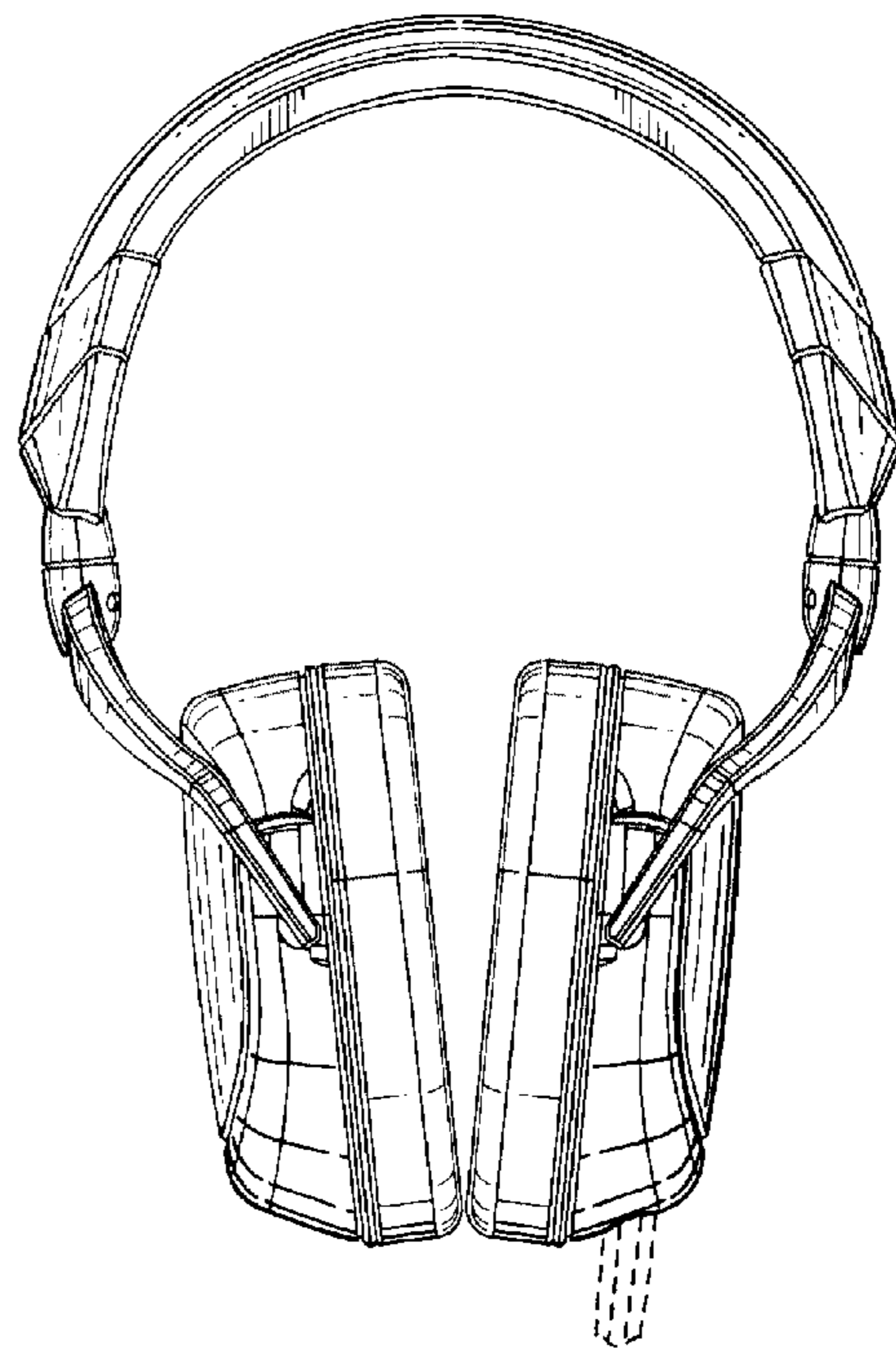
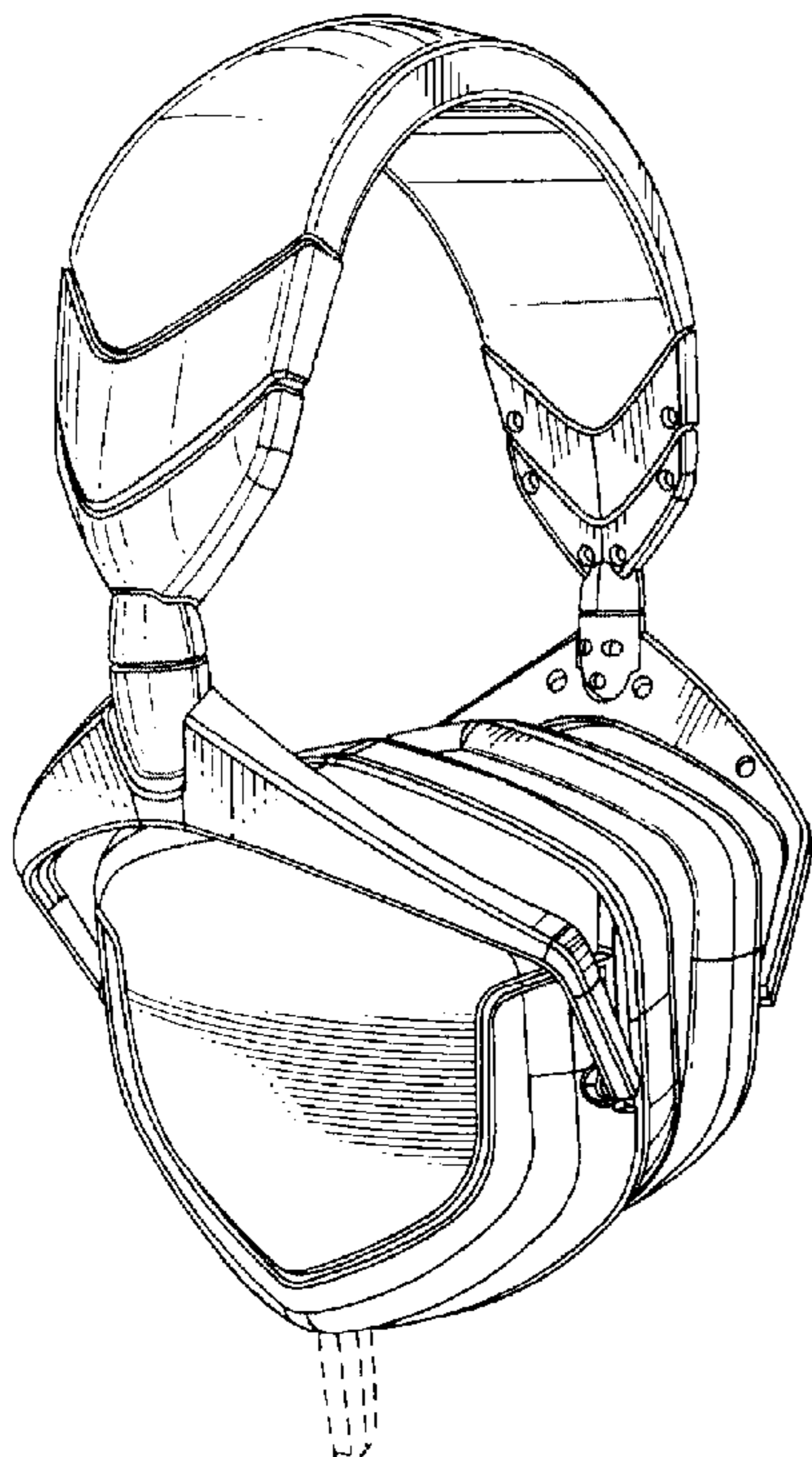
FIG. 4 is a left side view thereof;

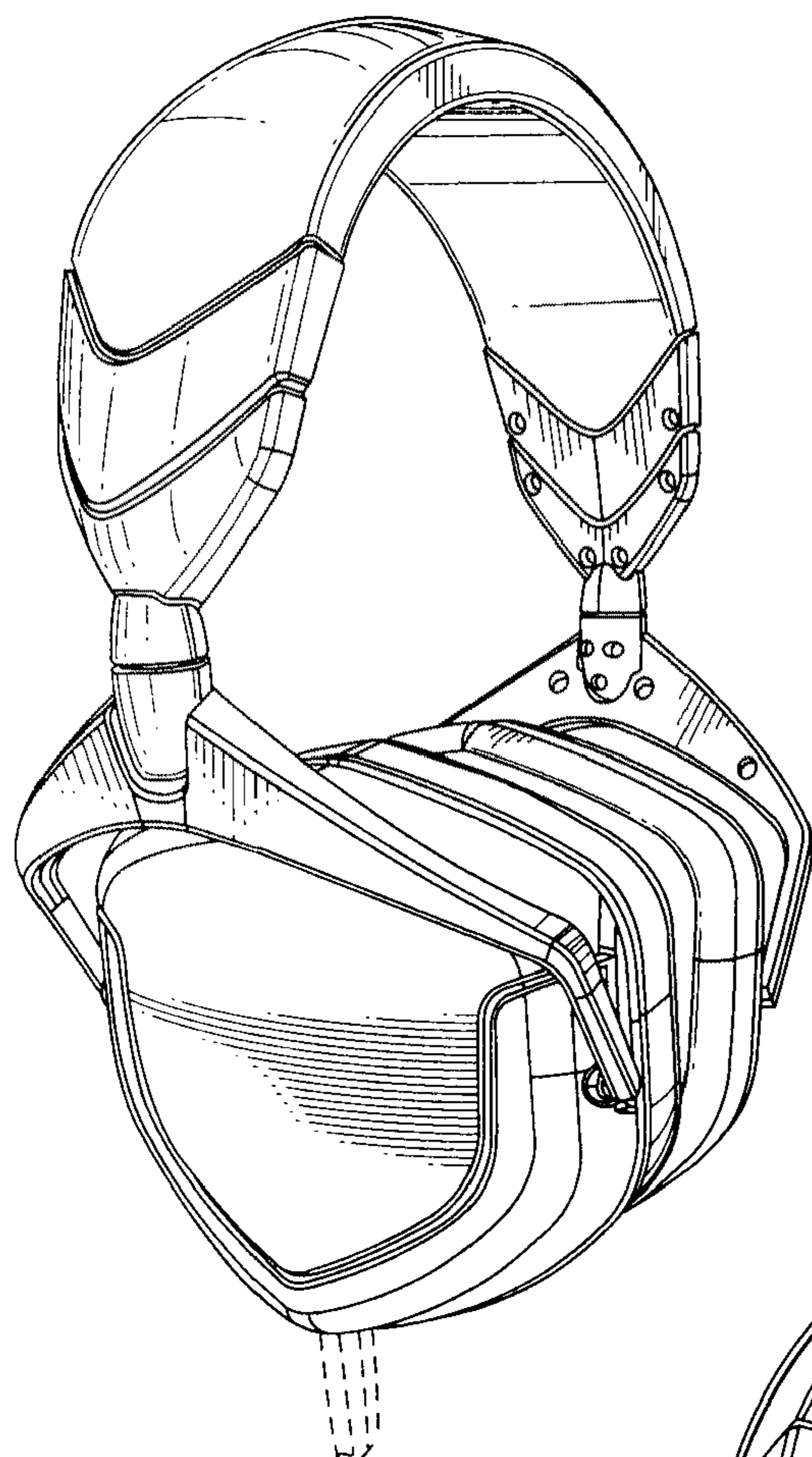
FIG. 5 is a right side view thereof; and,

FIG. 6 is a top view thereof.

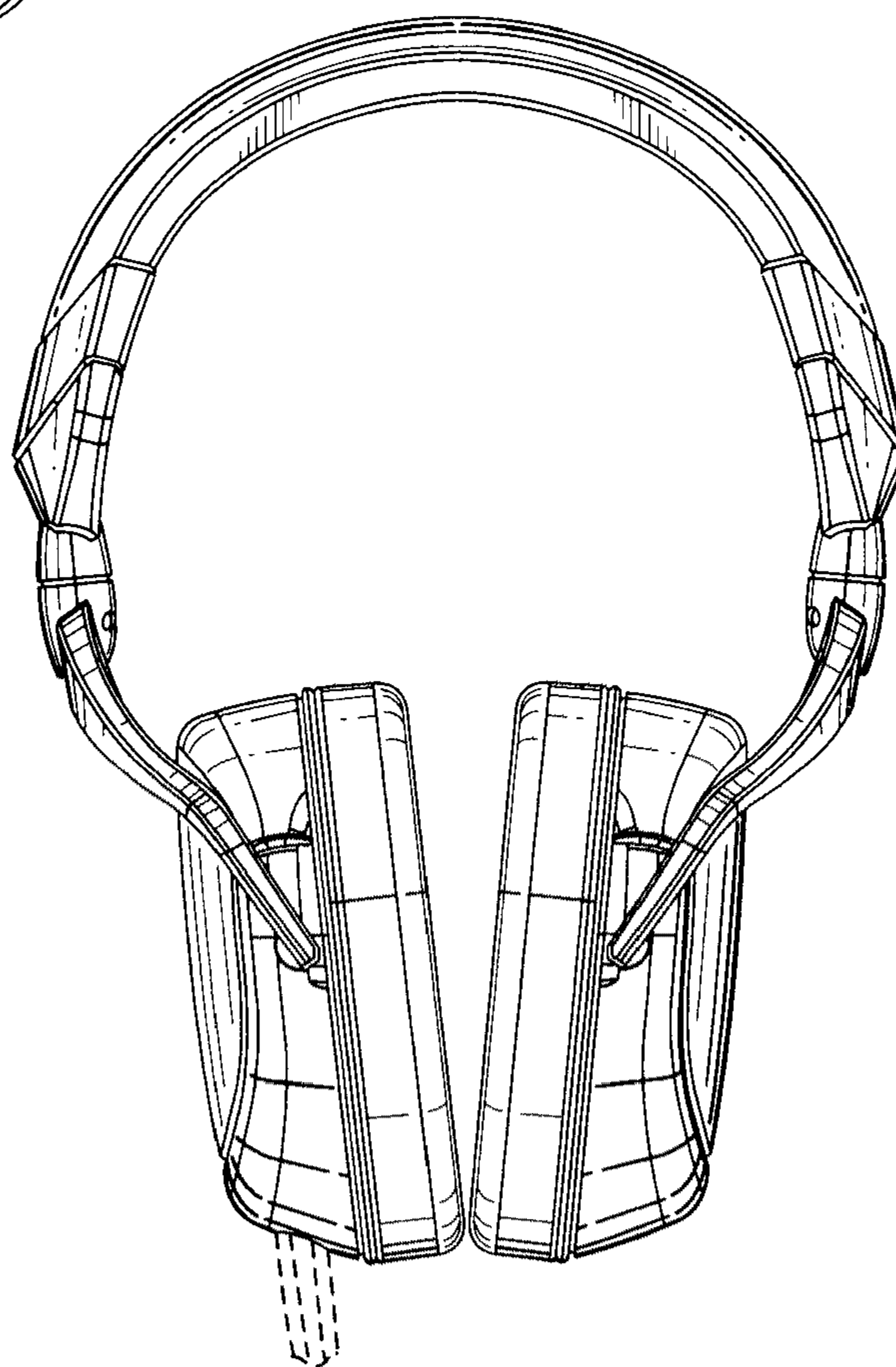
Portions of the drawings shown in dashed line are for illustrative purposes only, and form no part of the claimed design.

**1 Claim, 3 Drawing Sheets**

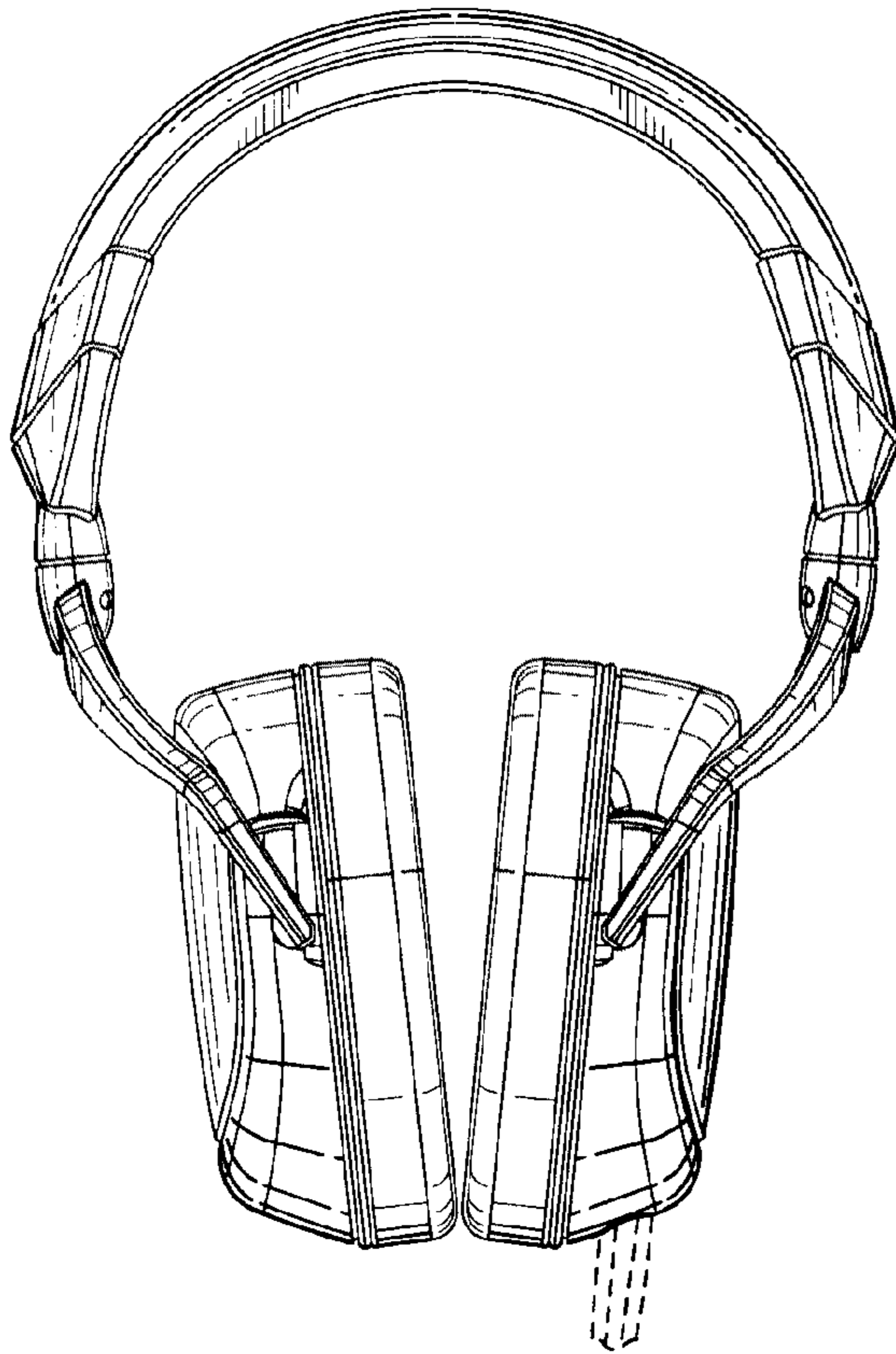




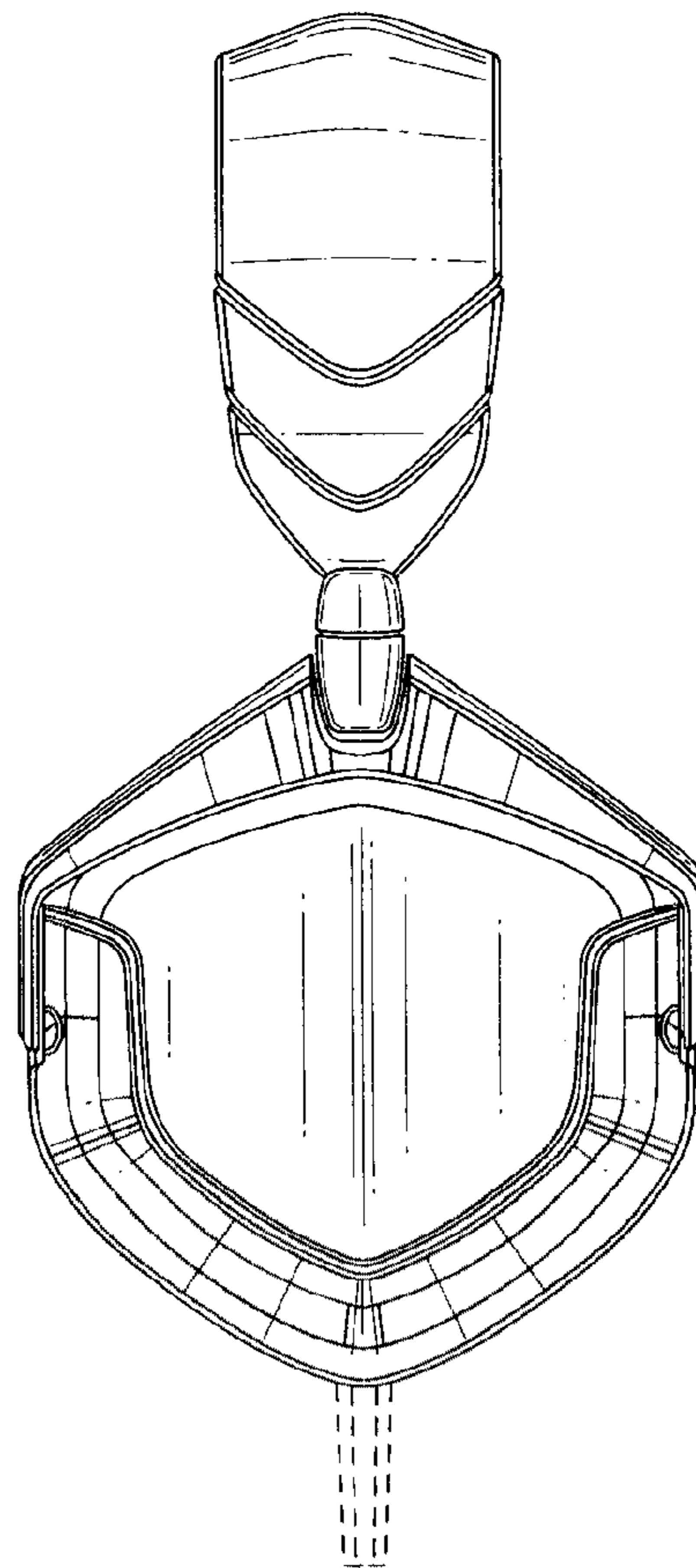
*Fig. 1*



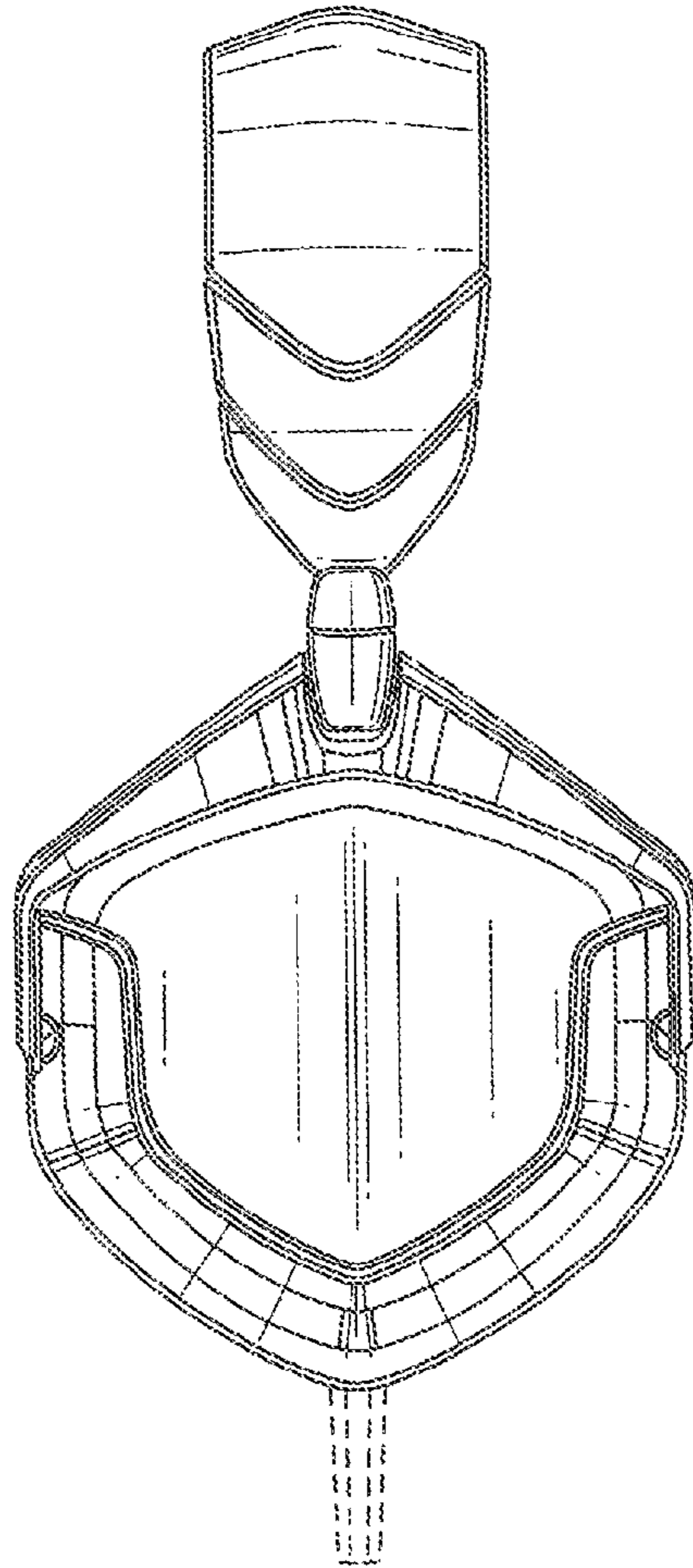
*Fig. 2*



*Fig. 3*



*Fig. 4*



*Fig. 5*

*Fig. 6*

